

IN THE CLAIMS:

The following is a complete listing of the claims in this application, reflects all changes currently being made to the claims, and replaces all earlier versions and all earlier listings of the claims:

1. (Previously Presented) A method for manufacturing an ink jet print head in which an ink flow path is formed by contacting a substrate for forming an ink discharging energy generating element with an ink flow path forming member for forming the ink flow path, said method comprising the steps of:

providing a layer on the substrate, at least a portion of the layer being polyether amide resin;
forming a pit on the substrate by performing anisotropic etching of the layer as an etching mask; and
providing the ink flow path forming member on the substrate so that the ink flow path forming member is in contact with the pit on the substrate.

2.-4. (Canceled)

5. (Previously Presented) An ink jet print head substrate formed by the method of an ink jet print head substrate according to claim 1.

6. (Previously Presented) A manufacturing method for making an ink jet print head using an ink jet print head substrate formed using the method according to

claim 1, wherein a discharge port for discharging ink, a liquid path communicating with the discharge port and also including the ink discharging energy generating element, a liquid flow path forming member attached with the substrate to form the liquid path are formed on the substrate.

7. (Previously Presented) The manufacturing method according to claim 6, wherein the pit is formed in proximity to both ends of a longitudinal direction in the ink jet print head.

8. (Previously Presented) An ink jet print head manufactured using the manufacturing method of an ink jet print head according to claim 6.

9. (New) An ink jet print head in which an ink flow path is formed by contacting a substrate for forming an ink discharging energy generating element with an ink flow path forming member for forming said ink flow path,

wherein said substrate is provided with a layer at least a portion of which is polyether amide resin and a pit which is provided at a location other than where said layer is provided, and

wherein said ink flow path forming member is spread from said substrate by said layer such that said ink flow path forming member is contact with said pit of said substrate.